

SPECIFICATION

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SPEC. NO.:	PS-514	6-XXXXX-XXX	REVISION:	Α
PRODUCT	NAME:	0.8 mm PITCH IDC CON	NECTOR	
PRODUCT	NO.	51416 51417 SERIES		

PREPARED:

CHECKED:

APPROVED:

BRAVE

BRAVE

DATE:
2018/12/27

DATE:
2018/12/27

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TITLE: 0.8 MM PITCH IDC CONNECTOR

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CES	Aces P/N: 51416,51417SERIES
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1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
Α	ECN-1905388	NEW SPEC	SHI,YANAN	2018.12.27



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2 SCOPE

This specification covers performance, tests and quality requirements for 0.8 mm pitch IDC connector.

Aces P/N: 51416Series,51417 Series

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish

Wire Connector

4.2.1 Terminal: High performance copper alloy.

Finish: (a) Contact Area: Refer to the drawing.

(b) Under plate: Refer to the drawing

4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

Header Connector:

4.2.3 Contact: High performance copper alloy.

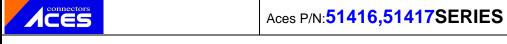
Finish: (a) Contact Area: Refer to the drawing.

(b) Under plate: Refer to the drawing.

- 4.2.4 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.5 Fitting Nail: Refer to the drawing.

Finish: Refer to the drawing.

- 4.3 Ratings
 - 4.3.1 Working voltage less than 36 volts (per pin)
 - 4.3.2 Voltage: 50 Volts DC
 - 4.3.3 Current: DC 0.7 Amperes AWG# 32
 - 4.3.4 Operating Temperature : -25°C to +85°C



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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
	Product shall meet requirements of	Visual, dimensional and functional
Examination of Product	applicable product drawing and	per applicable quality inspection
	specification.	plan.
	ELECTRICAL	
Low Level	Initial: 30 m Ω max.	Mate connectors and measure by
Contact Resistance	After: $40 \text{ m } \Omega$ max.	dry circuit, 20m V max. 10m A
- Contact Recictaries	7 (to): 10 111 <u>12</u> 111ax.	(EIA-364-23)
		Unmated connectors, apply
Insulation Resistance	100 M Ω Min.	500 V DC between adjacent
		terminals.
		(EIA-364-21)
Dialogtria		Mate connectors and apply 500 V
Dielectric	No Breakdown.	AC/rms for 1 minute between
Withstanding Voltage		adjacent terminal or ground
		(EIA-364-20)
		Mate connector: measure the
		temperature rise at rated current after:0.7 A/Power contact. The
Temperature rise	20°C May Change allowed	
	30°C Max. Change allowed	temperature rise above ambient shall not exceed 30° The ambient
		condition is still air at 25°C
		_
	MECHANICAL	(EIA-364-70 METHOD 2)
11	MECHANICAL	Ot an Jan J
Item	Requirement	Standard
		The sample should be mounted in
		the tester and fully mated and
Durability	30 cycles.	unmated the number of cycles
,		specified at the rate of
		25.4 ± 3mm/min.
		(EIA-364-09)
		Measure the force necessary to
		mate connector assemblies at a
Insertion /Extraction Forces	See item 6	maximum rate of 25.4mm per
(Mating/ Un-mating Force)	See item 0	minute.
		(EIA-364-13)
		<u></u>
147		Fix the crimped terminal ,apply axial
Wire pull out force	See item 9.	pull out force on the wire at speed
		rate of 25.4mm per minute.
		Apply axial pull out force at the
Terminal/Housing		speed rate of 25.4mm per minute on
	L3IN IVIID	
Retention force		the terminal assembly in the housing



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Vibration	1 µs Max.	Amplitude : 1.5 mm P-P Sweep		
Vibration	η μο ινιαχ.	time: 10-55-10 Hz in 1 minute		
		Duration: 2 hrs in each X.Y.Z. axis		
Shock	1 µs Max.	(EIA-364-28) Mate connectors and subject to the		
Shock	T μs Max.	following shock conditions. 3 shocks		
		shall be applied along 3 mutually		
		perpendicular axes, passing DC		
		1mA current during the test. (Total		
		of 18 shocks) Test Pulse: Half		
		SinePeak Value: 490m/s2 [50G]		
		(EIA-364-27)		
	ENVIRONMENTAL			
		Mate module and subject to follow		
		condition for 5 cycles.		
Thermal Shock	See Product Qualification and Test			
THEIMAI SHOCK	Sequence Group 4	-55 +0/-3 °C , 30 minutes		
		+85 +3/-0 °C, 30 minutes		
		(EIA-364-32, test condition I)		
		Mated Connector		
Humidity	See Product Qualification and Test	40°C, 90~95% RH, 96 hours.		
	Sequence Group 4	(EIA-364-31,Condition A, Method		
		Subject mated connectors to		
Tomporatura Life	See Product Qualification and Test			
Temperature Life	Sequence Group 5	hours.		
		(EIA-364-17, Test condition A)		
		Subject mated/unmated		
0 11 0		connectors to 5% salt-solution		
Salt Spray	See Product Qualification and Test			
(Only For Gold Plating)	Sequence Group 6	(I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours.		
		(EIA-364-26)		
Resistance to Soldering	Appearance:no damage contact	Temperature 260°C Max ,10 Sec		
heat	resistance:40 m Ω max	Max. IR reflows 2 times		
Coldor Ability	75% of immersed area must show			
Solder-Ability	no voids,pin holes	sec. (EIA-364-52)		
Hand Soldering	1			
Temperature Resistance	Appearance : No damage	T≧350°C , 3 sec at least		

6 Insertion / Extraction Force



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	ļ	Initial		
NO.OF.CKT	Insertion Force (Max.)	Withdrawal Force (Min.)	Withdrawal Force (Min)	
2	1.5KG	0.20KG	0.15KG	
3 4		0.20.10		
5				
6				
7	2.0KG	0.35KG	0.25KG	
8				
9 10				
11				
12				
13				
14	0.01/0	0.45140	0.05140	
15 16	3.0 KG	0.45KG	0.35KG	
17				
18				
20				

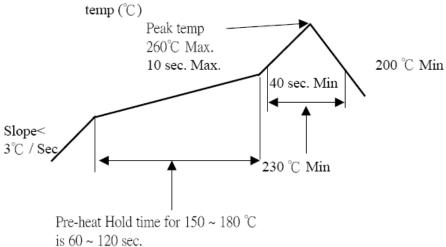


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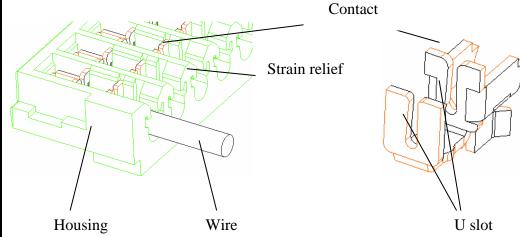
7 INFRARED REFLOW CONDITION

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



Lead-free Process

8 Applicable Specifications





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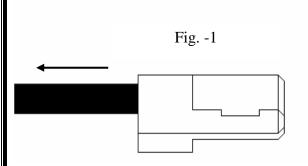
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9 Contact V.S Wire Retention Force Table

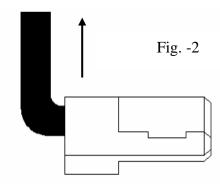
Insulation OD	Wire	Part No.	Material of insulation	Parallel	Perpendicular
Ф0.38±0.02	AWG #32 (UL10064)	51417-xxxxx-001	Halogen-free	6N min.	0.8N min.

Note:

If need retention force more that must use the UV glue.



Parallel Direction



Perpendicular Direction



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10 RODUCT QUALIFICATION AND TEST SEQUENCE

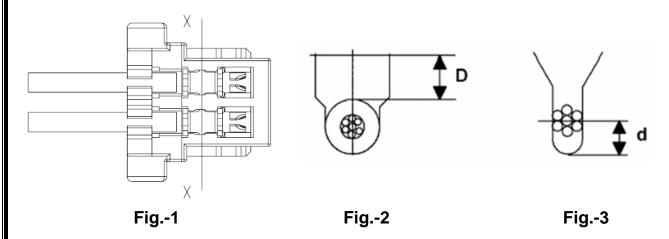
		Test Group								
Test or Examination	1	2	3	4	5	6	7	8	9	10
				Т	est Se	quenc	е		•	
Examination of Product		1 \ 5	1 \ 5	1 . 7	1、6	1 \ 4			1 \ 3	1 \ 3
Low Level Contact Resistance		2 . 7	2 ` 6	2、10	2 \ 9	2 ` 5			4	
Insulation Resistance				3 . 9	3 \ 8					
Dielectric Withstanding Voltage				4 \ 8	4 · 7					
Temperature Rise	1									
Mating / Unmating Force		3、6								
Durability		4								
Vibration			3							
Shock (Mechanical)			4							
Thermal Shock				5						
Humidity				6						
Temperature Life					5					
Salt Spray(Only For Gold Plating)						3				
Wire Pull Out Force							1			
Terminal / Housing Retention Force (Cable Side)								1		
Resistance to Soldering Heat									2	
Hand Soldering Temperature Resistance										2
Sample Size	2	4	4	4	4	4	4	4	4	4



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11 TERMINATION DEPTH



Measure termination depth dimension "D" in Fig.-2 at X-X part in Fig.-1 where is in then middle part of two U slots and a flattened part pressed by termination punch, and check it satisfies specified value in table

Exact termination depth is measure "d" between bottom of slot and position of center core wire of wire conductors as shown in Fig.-3; Aces specifies termination depth dimension "D" force to facilitate a time-consuming work of measuring "d" as a daily control.

Accordingly, dimension "D" becomes not reference value but control value for the use of the wire to be checked is Aces expect specified wires.

Wire Size	Insulation OD	Termination Depth D	d
AWG#32	Ф0.38±0.02mm	D=0.40±0.03mm	d=0.19±0.03mm

12 TERMINATION APPEARANCE

Inspect the following points after termination.

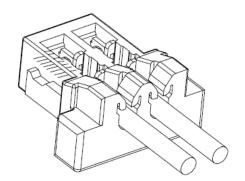
- 12.1 Punching flaws on housing caused by termination punch; Housing must be free from flaws. When connector set position deviation, scratches and deformation caused by termination punch may appear at the diagonally shaded areas in Fig.-4.
- 12.2 Flaws and deformation at beams of contact. Beams must be free from flaws and dimension. When connector set position deviation to wire axis direction, scratches and deformation caused by termination punch may appear at beams of contact as shown in Fig.-5.

In this case, not only contact but also termination die may be damaged.



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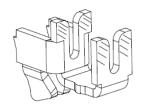


Fig.-4 Fig.-5

12.3 Exposure of wire conductors around beams of contact; Wire conductors must not be exposed. When connector set position deviates to wire axis direction, wire conductors may expose in front or back of beams of contact as shown in Fig.-6.

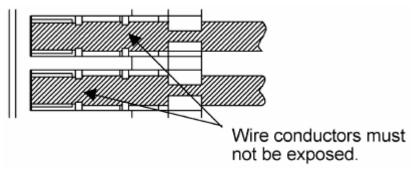


Fig.-6

12.4 Gap between housing wall and wire tip (Wire protruding length) Gap "G" between housing walls and wires tip in Fig.-7 should be 0.2 mm max.

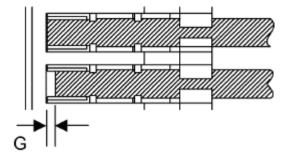


Fig.-7

connectors	Aces P/N:	Aces P/N: 51416,51417SERIES			
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12.5 Overrun of wire (Wire must not overrun) when wire tension is not adequate, overrun of wire may appear as shown in Fig.-8.

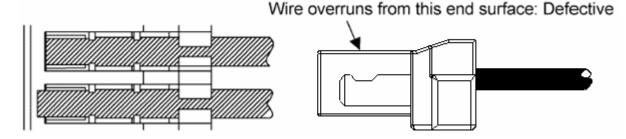
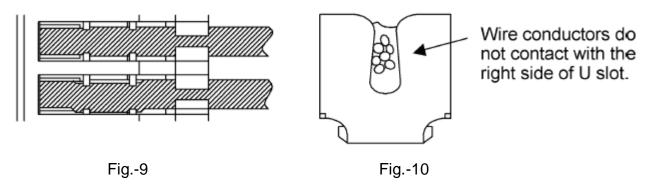


Fig.-8

12.6 Deviation of insulation displacement center (Deviation of insulation displacement center must not happen. When connector set position or wire deviates to pitch direction, termination punch, wire and U slots do not align so that insulation displacement center deviate as shown in Fig.-9 and Fig.-10



13 MATING/UNMATING METHOD CONNECTOR

13.1 Mating method of connector

Mated receptacle with header straight on same axis. When the position of mating part of header and receptacle is aligned, align one side of mating part of header with the end of receptacle within 20 degrees to mating axis as shown in Fig.-11.

Do not mate receptacle at the angle of 20 degrees or more, because such handling may cause breakage of connector, etc.

When position of receptacle and header is aligned, hold wires in a bundle in order to prevent applying external force to receptacle. Then, mate receptacle with header up to the back straight against mating axis.

Besides, after mating operation, check that there is no clearance between header and receptacle as shown in Fig.-12, because such clearance may lead discontinuity of connector.



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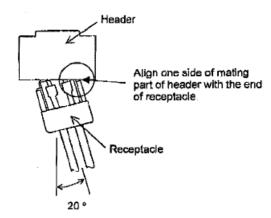


Fig.-11
Align the position (Side entry type)

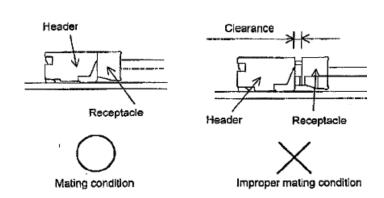


Fig.-12
Mating condition (Side entry type)

13.2 Unmating method of connector

Hold wires in a bundle and unmate receptacle from header on the same axis. At this time, conduct operation within 20 degrees to mating axis.

Do not unmate receptacle forcibly with prying more than 20 degrees, because such handing may cause breakage of connector, etc.

If receptacle is unmated with holding wire of only one end, such handling is the same as prying connector.

Beside, there is a possibility that wire may come off housing when they are unmated without holding in a bundle.

Even when all wires cannot be held in routing of wires, wire more than the number shown in the Table-1 should be held and unmated.

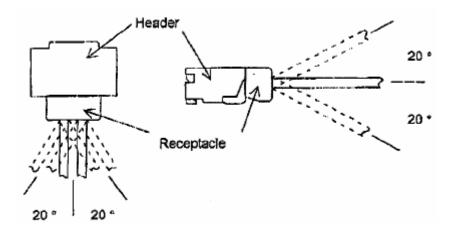


Fig.-13



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CKTS	Wires
2	hold 2 wires without fail
3~5	hold more than 3 wires
6~10	hold more than 4 wires
11~15	hold more than 5wires
16~20	hold more than 6 wires

Table -1

13.3 Routing of wire

In routing wire, careful operation is required so that tension more than 1N may not be applied per connector and one wire (one circuit).

14 ACES APPLICATION SOP

When the IDC cable after crimping , we suggest that the IDC Cable can be glued .This can ensure better wire pull out force.

